Drill Table

<table>
<thead>
<tr>
<th>Symbol</th>
<th>Quantity</th>
<th>Finished Hole Size</th>
<th>Plated</th>
<th>Hole Type</th>
<th>Physical Length</th>
<th>Haut Path Length</th>
</tr>
</thead>
<tbody>
<tr>
<td>a</td>
<td>1</td>
<td>20.00mm (0.8000&quot;)</td>
<td>NPHT</td>
<td>Slot</td>
<td>80.00mm (3.1500&quot;)</td>
<td>40.00mm (1.5750&quot;)</td>
</tr>
<tr>
<td>b</td>
<td>1</td>
<td>2.00mm (0.0780&quot;)</td>
<td>NPHT</td>
<td>Slot</td>
<td>80.00mm (3.1500&quot;)</td>
<td>40.00mm (1.5750&quot;)</td>
</tr>
<tr>
<td>c</td>
<td>1</td>
<td>2.00mm (0.0780&quot;)</td>
<td>NPHT</td>
<td>Slot</td>
<td>80.00mm (3.1500&quot;)</td>
<td>40.00mm (1.5750&quot;)</td>
</tr>
<tr>
<td>d</td>
<td>1</td>
<td>2.00mm (0.0780&quot;)</td>
<td>NPHT</td>
<td>Slot</td>
<td>80.00mm (3.1500&quot;)</td>
<td>40.00mm (1.5750&quot;)</td>
</tr>
</tbody>
</table>

Copper thickness is 2.0oz.

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